

Updated C2M COM Simulations

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IEEE 802.3ck Adhoc Meeting

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Overview

❑ **COM 2.5.8 generally produces improved results compare to COM 2.5.7**

- COM results are now with $fr=0.75$ and does improve results on high ICN channels
- Other changes from Long Beach presentation are
 - Low frequency Fz adjusted to Baudrate/40
 - TP1a termination adjusted to $50\ \Omega$

❑ **Channel investigated**

- TE/Tracy OSFP micro-via channels exceed 3 dB COM with 5 T FFE
- TE/Tracy OSFP Long Barrel Via some channels do not meet 3 dB COM with 5 T FFE
- Cisco/Lim QSFP-dd channels exceed 3 dB COM with 5T FFE

❑ **The TP1a/TP5 are observed with weak generic equalizer**

- The actual equalizer may need additional capability to recover the signal at slicer.

COM Code 2.5.8

❑ Filter coefficient selected to have the improved CL120E response scaled for 53.1 GBd

– http://www.ieee802.org/3/ck/public/tools/tools/mellitz_3ck_01_0119_COM2p58.zip

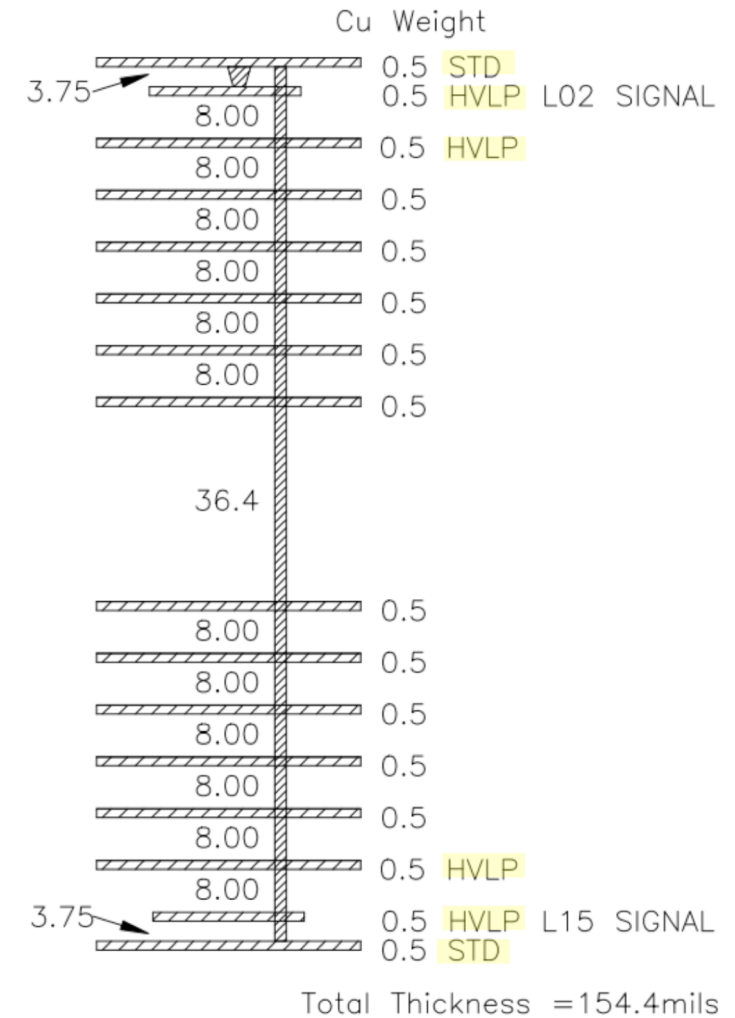
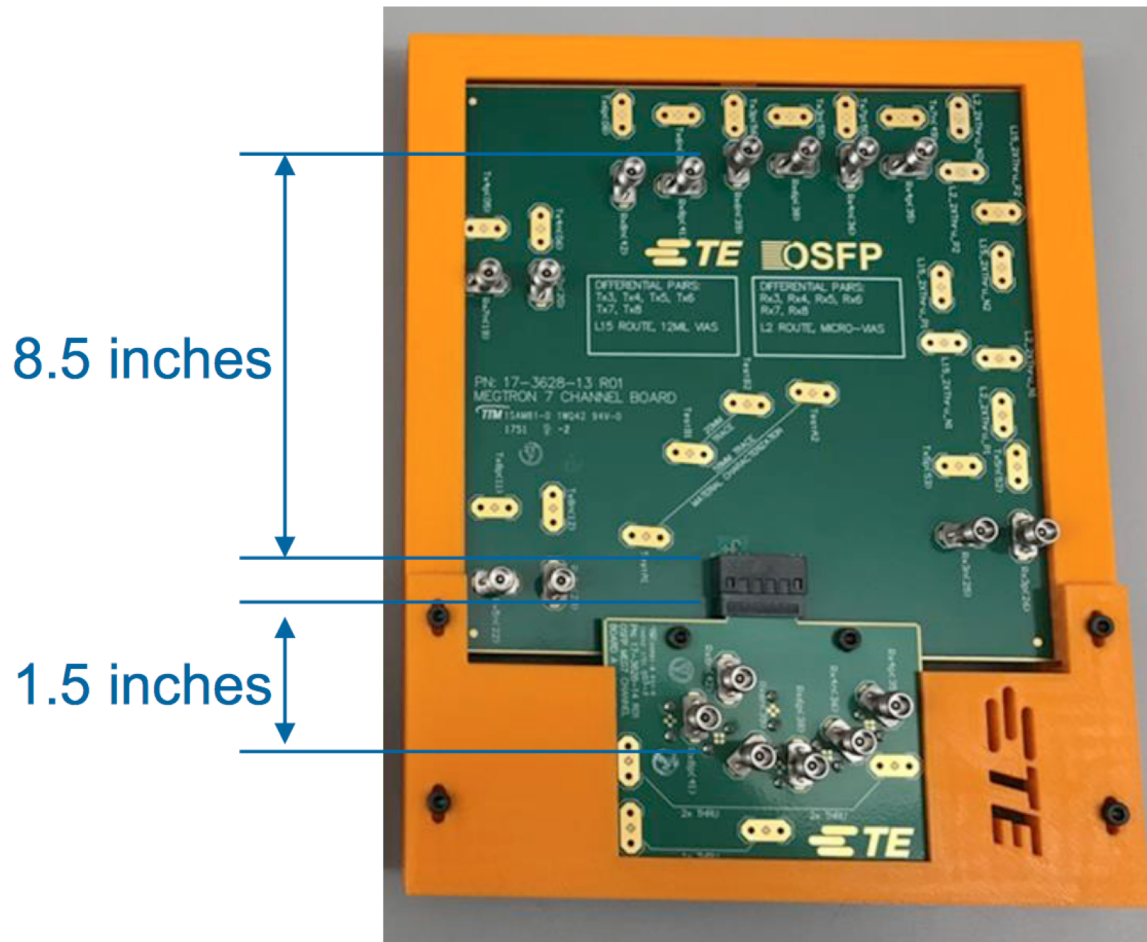
Table 93A-1 parameters			
Parameter	Setting	Units	Information
f_b	53.1	GBd	
f_min	0.05	GHz	
Delta_f	0.01	GHz	
C_d	[0.9e-4 0]	nF	[TX RX]
z_p select	[1 2]		[test cases to run]
z_p (TX)	[15 30; 1.8 1.8]	mm	[test cases]
z_p (NEXT)	[15 30; 1.8 1.8]	mm	[test cases]
z_p (FEXT)	[15 30; 1.8 1.8]	mm	[test cases]
z_p (RX)	[0 0; 0 0]	mm	[test cases]
C_p	[0.9e-4 0]	nF	[TX RX]
R_0	50	Ohm	
R_d	[45 50]	Ohm	[TX RX]
A_v	0.45	V	
A_fe	0.45	V	
A_ne	0.63	V	
L	4		
M	32		
filter and Eq			
f_r	0.75	*fb	
c(0)	0.65		min
c(-1)	[-0.2:0.02:0]		[min:step:max]
c(-2)	[0:.02:0.1]		[min:step:max]
c(1)	[-0.1:0.02:0]		[min:step:max]
N_b	0	UI	
b_max(1)	0.5		
b_max(2..N_b)	0.2		
g_DC	[-14:0.5:-4]	dB	[min:step:max]
f_z	18.55345912	GHz	
f_p1	53.1	GHz	
f_p2	28.2	GHz	
g_DC_HP	[-3:0.5:-1]		[min:step:max]
f_HP_P2	1.3275	GHz	
ffe_pre_tap_len	0	UI	
ffe_post_tap_len	4	UI	
Include PCB	0	logical	
ffe_tap_step_size	0		
ffe_main_cursor_min	0.7		
ffe_pre_tap1_max	0.3		
ffe_post_tap1_max	0.3		
ffe_tapn_max	0.125		
ffe_backoff	1		

I/O control		
DIAGNOSTICS	1	logical
DISPLAY_WINDOW	1	logical
CSV_REPORT	1	logical
RESULT_DIR	.\results\100GEL_WG_{date}\	
SAVE_FIGURES	0	logical
Port Order	[1 2 3 4]	
RUNTAG	C2M_1218	
COM_CONTRIBUTION	0	logical
Operational		
COM Pass threshold	1	dB
ERL Pass threshold	5	dB
DER_0	1.00E-05	
T_r	6.16E-03	ns
FORCE_TR	1	logical
TDR and ERL options		
TDR	1	logical
ERL	1	logical
ERL_ONLY	0	logical
TR_TDR	0.01	ns
N	300	
TDR_Butterworth	1	logical
beta_x	1.70E+09	
rho_x	0.18	
fixture delay time	0	
Receiver testing		
RX_CALIBRATION	0	logical
Sigma BBN step	5.00E-03	V
Noise, jitter		
sigma_RJ	0.01	UI
A_DD	0.02	UI
eta_0	8.20E-09	V^2/GHz
SNR_TX	33	dB
R_LM	0.95	

Table 93A-3 parameters		
Parameter	Setting	Units
package_tl_gamma0_a1_a2	[0 0.0009909 0.0002772]	
package_tl_tau	6.1400E-03	ns/mm
package_Z_c	[87.5 87.5 ; 92.5 92.5]	Ohm
Table 92-12 parameters		
Parameter	Setting	
board_tl_gamma0_a1_a2	[0 3.8206e-04 9.5909e-05]	
board_tl_tau	5.790E-03	ns/mm
board_Z_c	90	Ohm
z_bp (TX)	50	mm
z_bp (NEXT)	50	mm
z_bp (FEXT)	50	mm
z_bp (RX)	0	mm

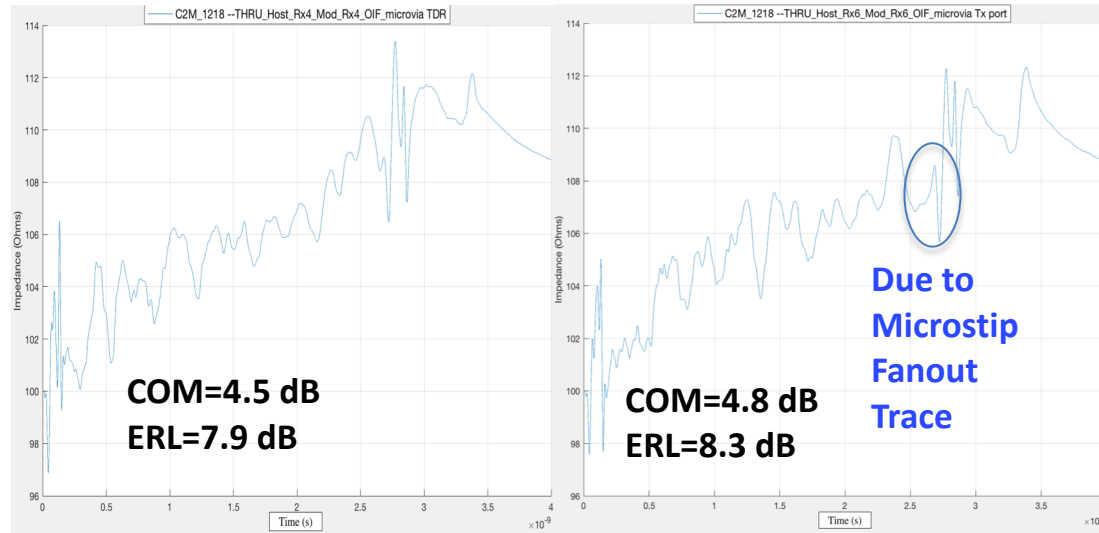
Tracy OSFP Board

- Board uses microvias as well as long barrel 154.4 mils vias with 3.75 mils stub.



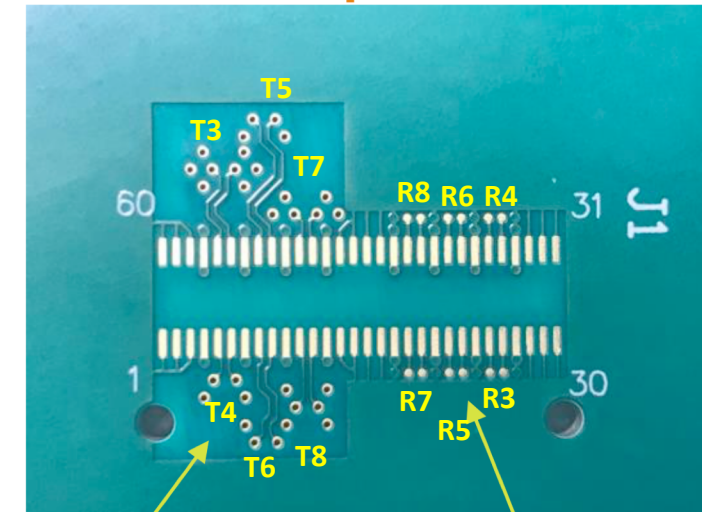
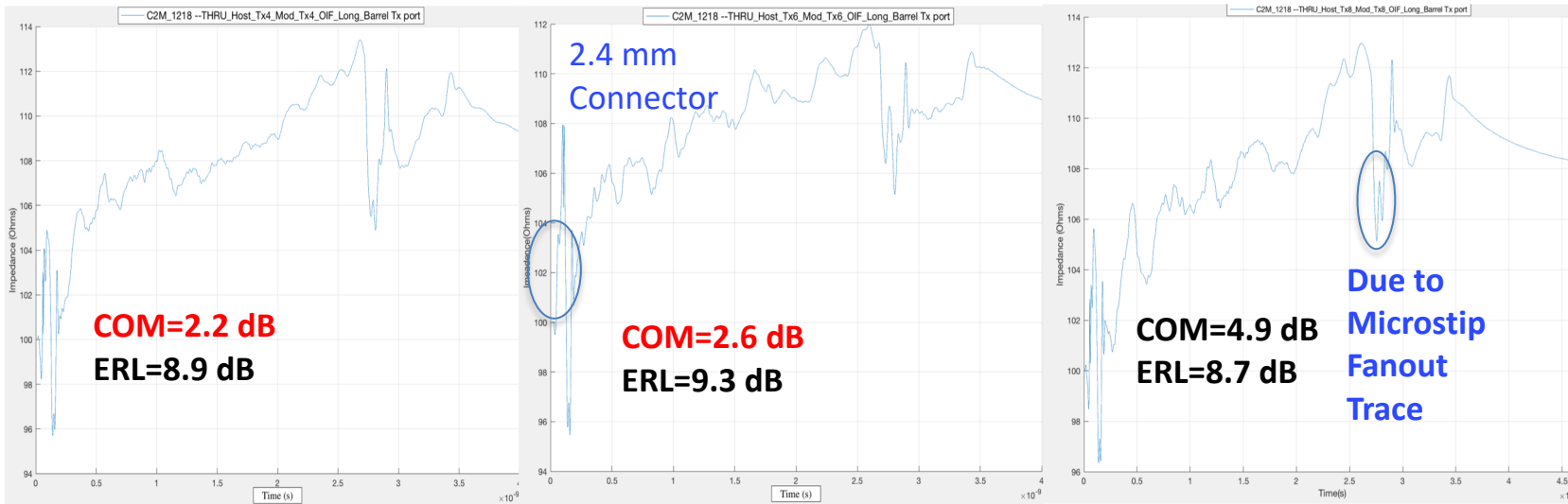
Tracy Microvia and Long Barrel Via Channels TDR T4 and T6

Microvia TE RX4 and RX6 Channels.



- 3.75 mils via stub is unlikely as the source of degradation.
- 154.4 mils long via likely a source of degradation.
- Microstip fanout trace likely another source of degradation.
- 2.4 mm connector on T6 has 20 Ω swing.
- Tracy channels include connector and may double count Cp.

TE TX4, TX6, and TX8 Long barrel via channels.



COM Analysis of Tracy Channels

8.5" OSFP (16 dB) channels, CK package reduces loss but increases ILD at significant COM penalty!

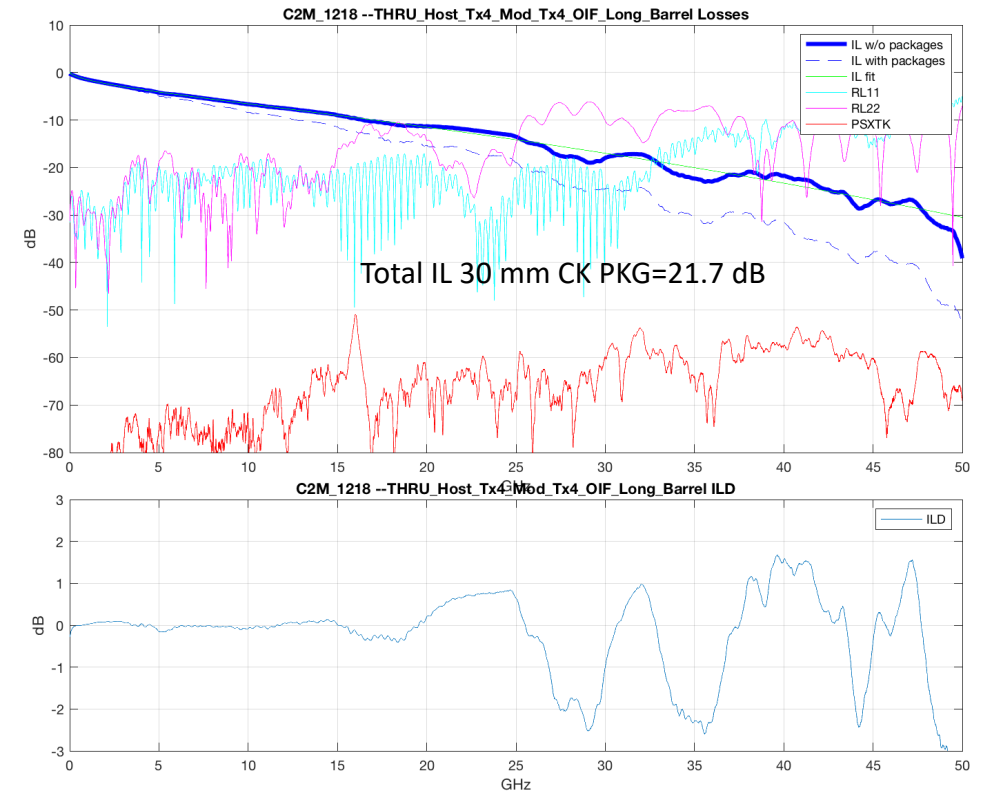
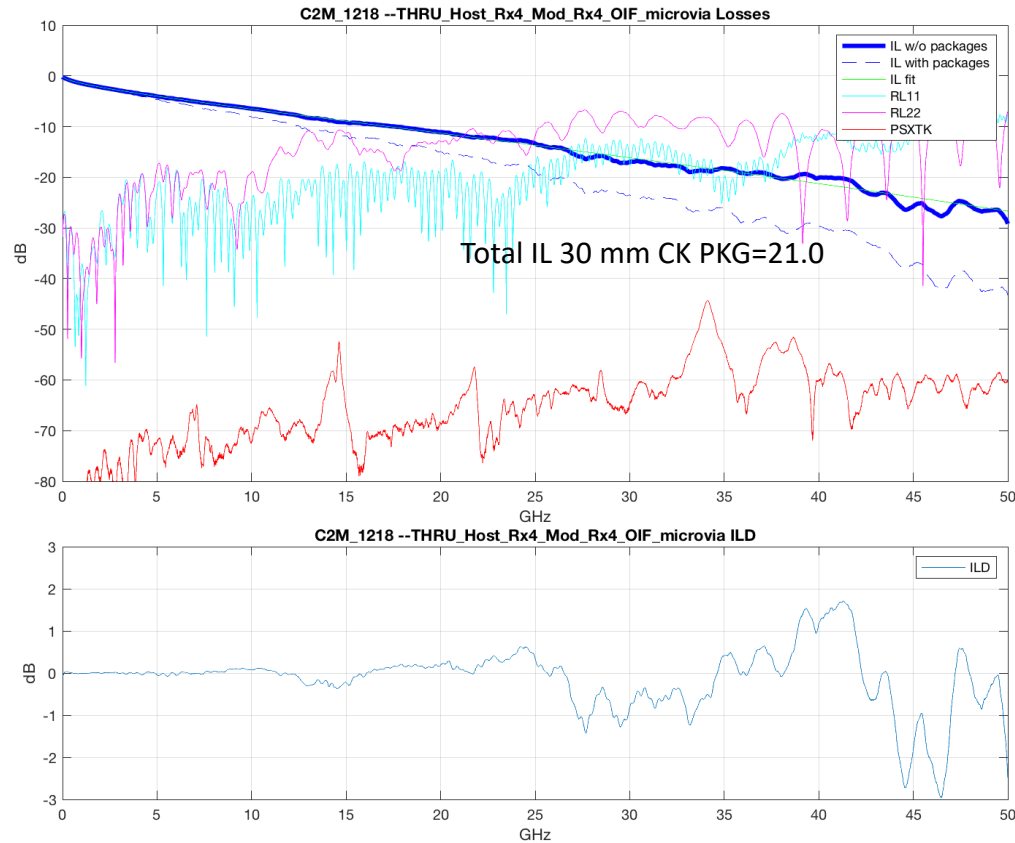
- http://www.ieee802.org/3/100GEL/public/tools/c2m/tracy_100GEL_02_0118.zip (long barrel)
- http://www.ieee802.org/3/100GEL/public/tools/c2m/tracy_100GEL_06_0118.zip (Micro Via).

Tracy T4 MicroVia, FOM_ILD=0.20, ICN=0.62 mV, ICR=48, ERL11=14.1, ERL22=7.9, COM=4.54 (5.22) dB, EH=15.6 (14.4) mV, VEC=7.8 (6.9) dB

Tracy T4 LongBarrel, FOM_ILD=0.38, ICN=0.51 mV, ICR=46, ERL11=14.7, ERL22=8.9

5T FFE - CK PKG: COM=2.2 (3.06) dB, EH=7.8 (8.6) mV, VEC=12.9 (10.5) dB

7T FFE - CK PKG: COM=3.8 (4.53) dB, EH=12.3 (12.3) mV, VEC=9.0 (7.8) dB



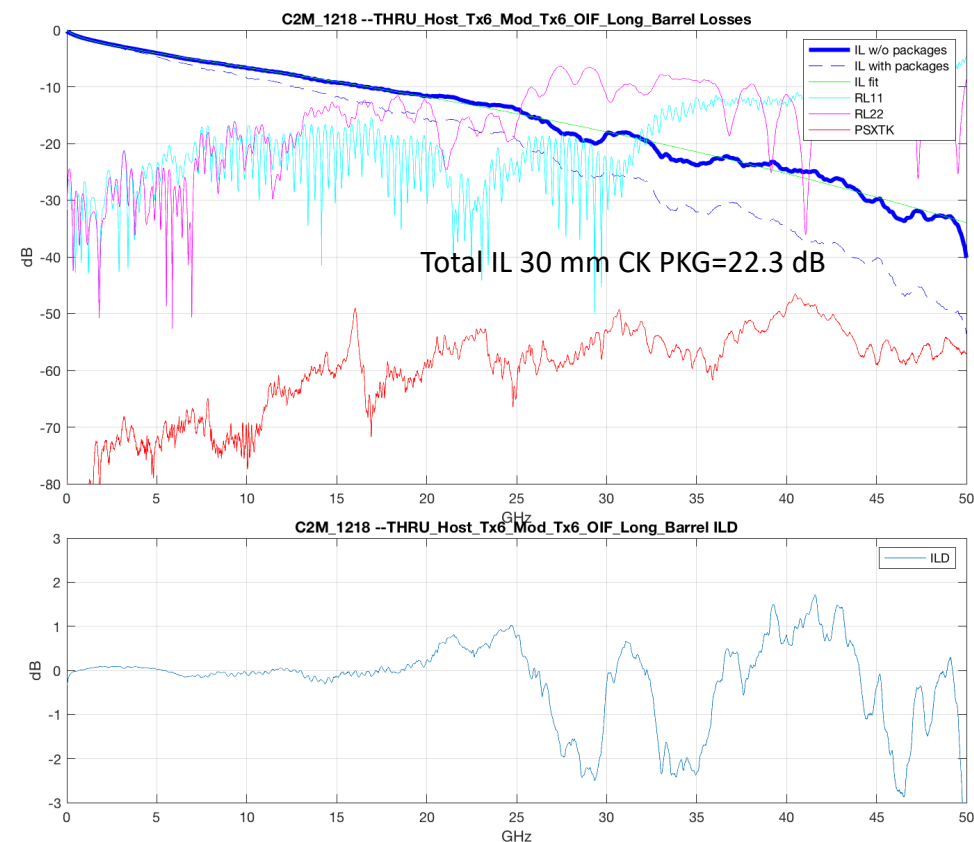
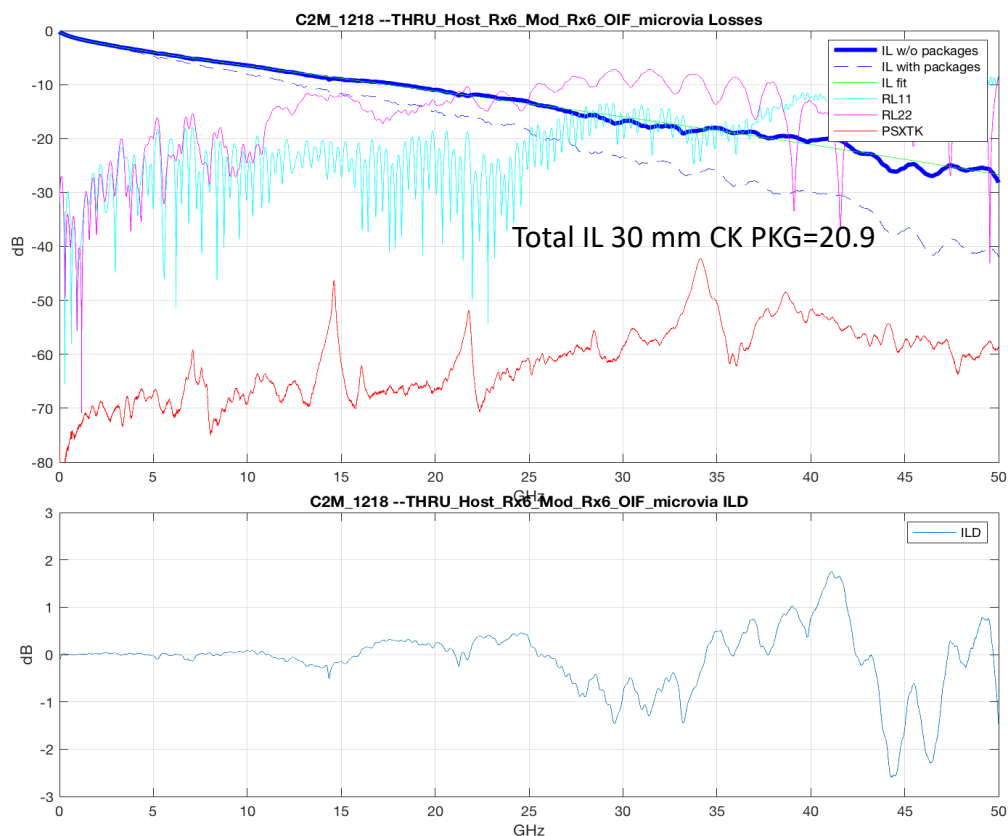
Result in (x) are for 30 mm PKG.

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- http://www.ieee802.org/3/100GEL/public/tools/c2m/tracy_100GEL_02_0118.zip (long barrel)
- http://www.ieee802.org/3/100GEL/public/tools/c2m/tracy_100GEL_06_0118.zip (Micro Via).

Tracy T6 MicroVia, FOM_ILD=0.21, ICN=0.91 mV, ICR=46, ERL11=15.4, ERL22=8.3
5T FFE: COM=4.7 (5.7) dB, EH=16.7 (15.8) mV, VEC=7.6 (6.3) dB
7T FFE: COM=4.8 (5.8) dB, EH=18.1 (17.6) mV, VEC=7.5 (6.3) dB



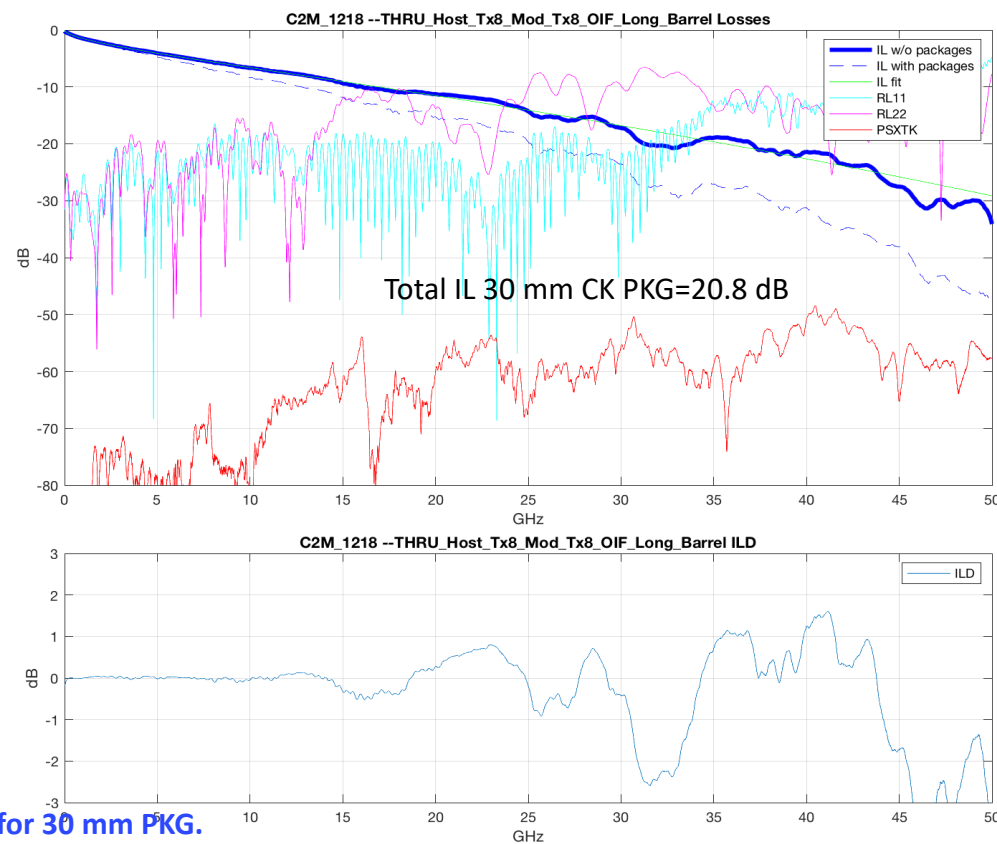
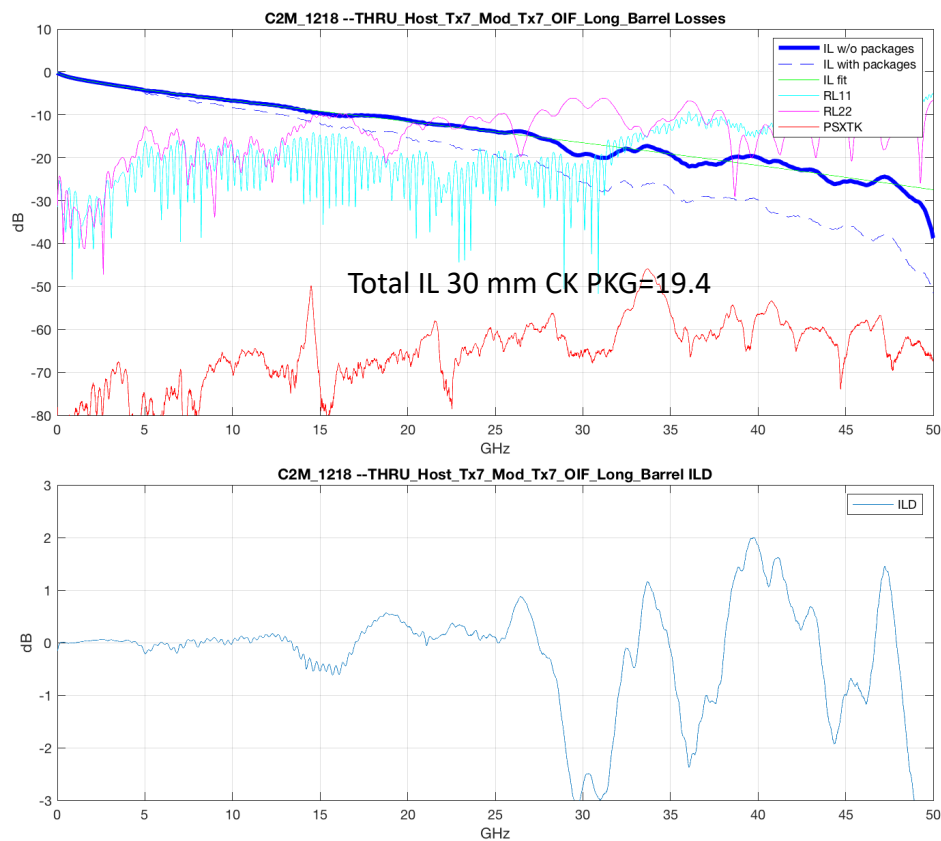
Result in (x) are for 30 mm PKG.

COM Analysis of Tracy Channels

8.5" OSFP (16 dB) channels, CK package reduces loss but increases ILD at significant COM penalty!

- http://www.ieee802.org/3/100GEL/public/tools/c2m/tracy_100GEL_02_0118.zip (long barrel)
- http://www.ieee802.org/3/100GEL/public/tools/c2m/tracy_100GEL_06_0118.zip (Micro Via).

Tracy T7 LongBarrel, FOM_ILD=0.39, ICN=0.66 mV, ICR=48, ERL11=13.0, ERL22=7.3
5T FFE: COM=2.8 (3.9) dB, EH=10.8 (12.9) mV, VEC=11.2 (8.9) dB
7T FFE: COM=3.02 (4.0) dB, EH=10.8 (12.3) mV, VEC=10.6 (8.6) dB



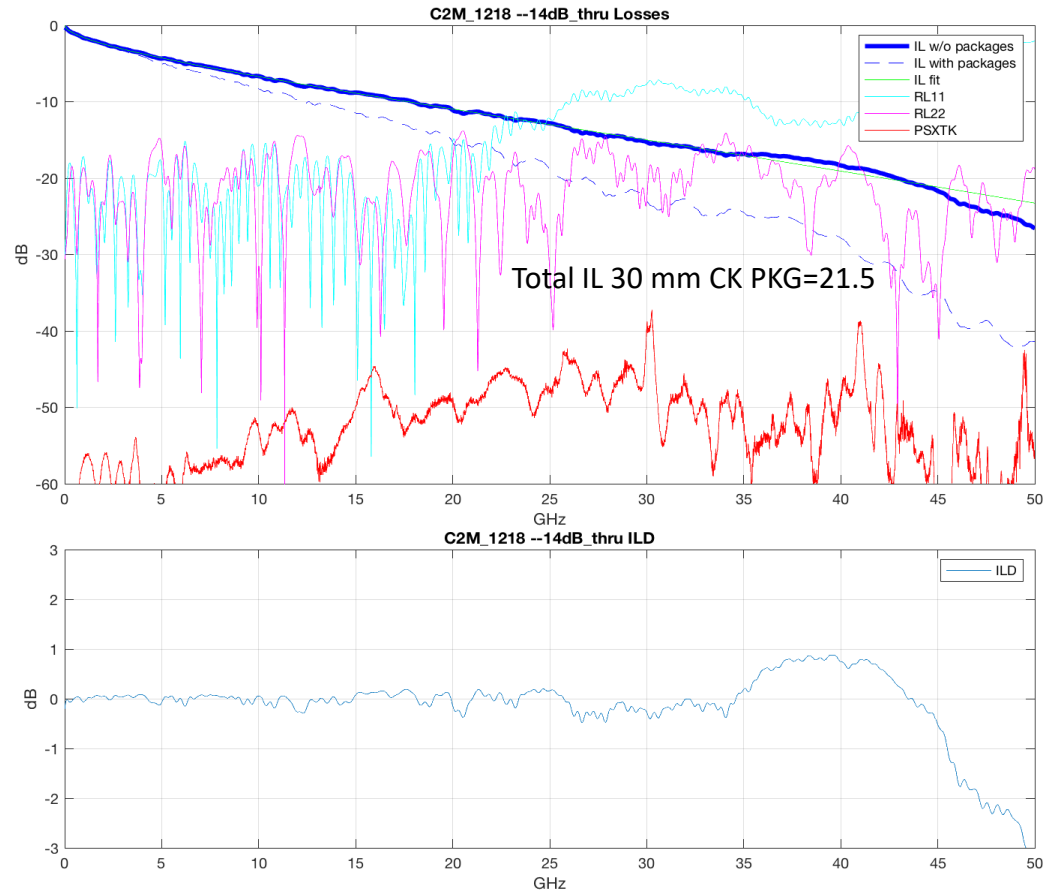
Result in (x) are for 30 mm PKG.

COM Analysis on Lim Nov-18 Channels (Legacy Contacts)

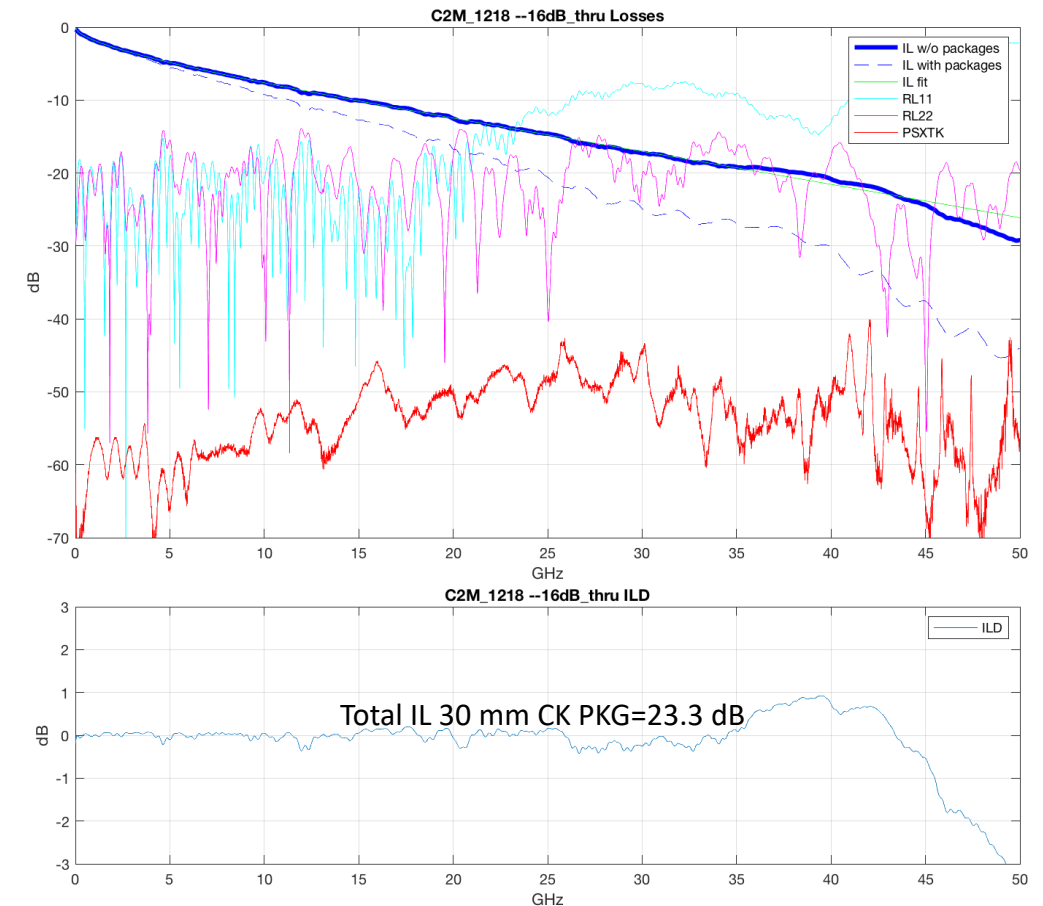
- Lim Nov-2018 channel ICR still pretty low ~30 dB and with high ICN, but the crosstalk peak at 15 GHz eliminated, with this improvement passes with good margin on 30 mm package

— http://www.ieee802.org/3/ck/public/tools/c2m/lim_3ck_01_0918_QDD_legacy_pairs.zip

Lim 14 dB FOM_ILD=0.11, ICN=2.72 mV, ICR=31.5, ERL11=9.1, ERL22=12.2
5T FFE: COM=3.15 (4.46) dB, EH=14.9 (17.2) mV, VEC=10.3 (7.9) dB



Lim 16 dB, FOM_ILD=0.11, ICN=2.32 mV, ICR=30.3 dB, ERL11=9.4, ERL22=12.3
5T FFE: COM=3.22 (4.92) dB, EH=12.4 (14.4) mV, VEC=10.2 (7.3) dB



Result in (x) are for 30 mm PKG.

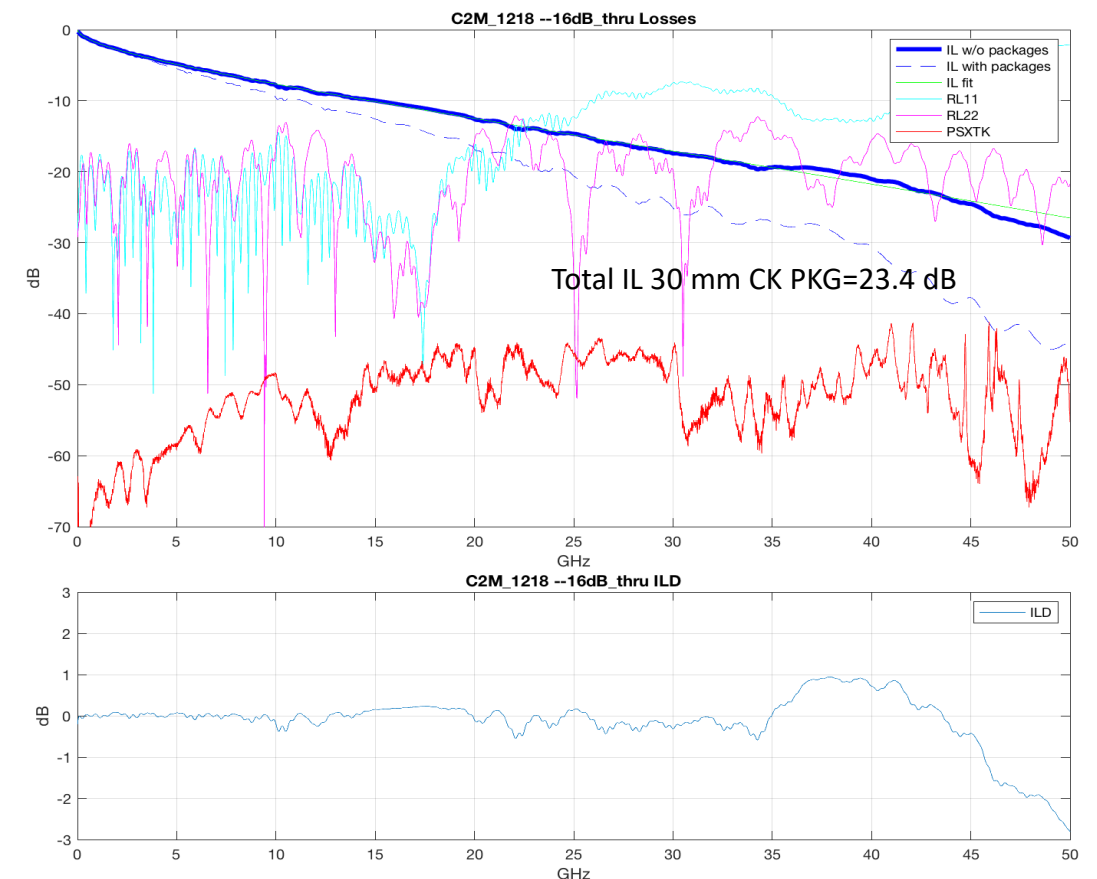
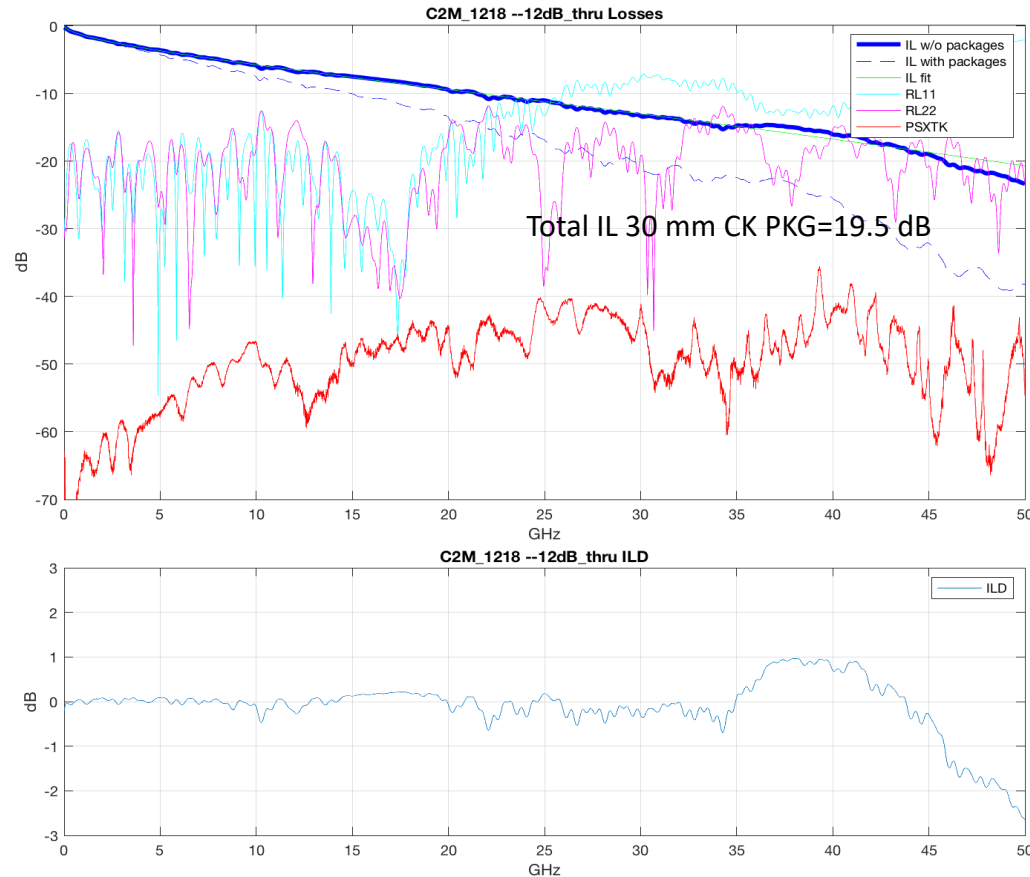
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COM Analysis on Lim Nov-18 Channels (new contacts)

- Lim Nov-2018 channel ICR still pretty low ~30 dB and with high ICN, but the crosstalk peak at 15 GHz eliminated, with this improvement passes with good margin on 30 mm package

— http://www.ieee802.org/3/ck/public/tools/c2m/lim_3ck_01_0918_QDD_new_pairs.zip

Lim 12 dB, FOM_ILD=0.126, ICN=3.65 mV, ICR=30.2 dB, , ERL11=8.7, ERL22=11.5
5T FFE: COM=3.21 (4.66) dB, EH=18.1 (23.0) mV, VEC=10.2 (7.6) dB



Result in (x) are for 30 mm PKG.

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Summary

- ❑ **The 5 tap low power FFE equalizer may not be sufficient unless ILD, ICN, and channel reflections are better controlled**
 - The source of problems are long barrel vias and fan-in traces on 0.6 mm pitch connectors
- ❑ **The new CK package with addition of PTH results in higher ILD/reflections and penalizes C2M applications more than LR where the equalizes can cancel package double reflections**
 - The addition of PTH is consistent with most large ASIC requiring core but the 1.8 mm core could be reduced to 1 mm
 - The addition of PTH on channel with high ILD/Low ERL may result in 1-2 dB COM penalty see [Ghiasi 3ck-01c 0119](#)
- ❑ **Updated results using COM 2.5.8 on TE/Tracy and Cisco/Lim channels are promising to assume 5T FFE for TP1a reference equalizer**
 - TE/Tracy OSFP micro-via channels all exceed 3 dB COM with 5 T FFE
 - TE/Tracy OSFP Long Barrel Via some channels do not meet 3 dB COM with 5 T FFE but pass 3 dB COM with 7T FFE
 - The primary degradation of long barrel via channels are due to length of via length and the microstrip fan-out at OSFP connector
 - Via stub of 3.75 mils is not expected to be one of primary degradation source but conventional back drilled via with ~ 7 mils would be one of the primary source of degradation
 - Cisco/Lim QSFP-dd channels exceed 3 dB COM with 5T FFE
- ❑ **Instead of defining hard limit on ILD, ICN, IL, or ERL, COM can be used as the tool for channel goodness**
 - TE RX6 micro via having ER of 8.3 has 4.7 dB COM but TE TX6 long barrel via with ERL of 9.3 has COM of only 2.6 dB
 - Cisco Lim 12 dB channel with high ICN of 3.65 mV passes COM
 - If we have to add some channel constrains it would have be a set lax limits as we don't want good channel to fail such as: $ILD < 0.25$, $ICR < 31$ dB, and $ERL < 7.8$ dB or just simplify the acceptance by using COM of 3 dB!